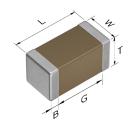
积层贴片陶瓷片式电容器

C1608X5R1E106M080AC

RoHS Reach Halogen Free Pb Free

交货型号	C1608X5R1E106MT****
用途	─般等级
特点	General 一般(~75V)
系列	C1608 [EIA 0603]
状态	量产体制



尺寸		
长度(L)	1.60mm ±0.20mm	
宽度(W)	0.80mm ±0.20mm	
厚度(T)	0.80mm ±0.20mm	
端子宽度(B)	0.20mm Min.	
端子间隔(G)	0.30mm Min.	
推荐焊盘布局(PA)	0.70mm to 1.00mm(Flow Soldering)	
)E47.件血加加 (LA)	0.60mm to 0.80mm (Reflow Soldering)	
推荐焊盘布局(PB)	0.80mm to 1.00mm(Flow Soldering)	
1世行。序血和/p (t D)	0.60mm to 0.80mm (Reflow Soldering)	
推荐焊盘布局(PC)	0.60mm to 0.80mm(Flow Soldering)	
1世代が年前41月以口)	0.60mm to 0.80mm (Reflow Soldering)	

电气特性		
电容	10 μ F ±20%	
额定电压	25VDC	
温度特性	$X5R(\pm 15\%)$	
耗散因数(Max.)	10%	
绝缘电阻 (Min.)	10ΜΩ	

	其他
M1 +0c>->+	流体
焊接方法	回流
AEC-Q200	NO
包装形式	纸编带 (180mm卷筒)
包装个数	4000pcs

[!] Images are for reference only and show exemplary products.

[!] This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

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特性图表(这是参考数据,并不保证产品的特性。)

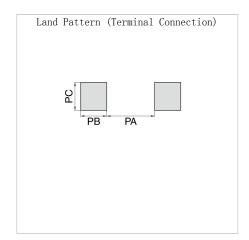
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Associated Images



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